

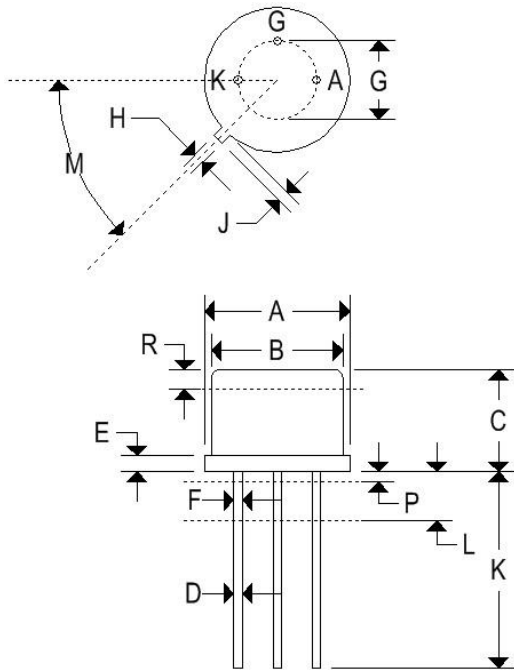
# DIGITRON SEMICONDUCTORS

## MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

DATE 31 MARCH 2022

### CASE TO-205 LOW PROFILE THROUGH HOLE

<b>CASE</b>	HERMETICALLY SEALED METAL CAN
<b>MARKING</b>	ALPHA NUMERIC
<b>WEIGHT</b>	1 GRAM (APPROXIMATE)



Dim	TO-205 Low Profile			
	Inches		Millimeters	
	Min	Max	Min	Max
A	0.350	0.375	8.89	9.39
B	0.305	0.335	7.73	8.50
C	-	0.180	-	4.57
D	0.016	0.023	0.41	0.58
E	-	0.050	-	1.27
F	0.016	0.021	0.41	0.53
G	0.200 TP		5.060 TP	
H	0.026	0.034	0.71	0.86
J	0.029	0.045	0.74	1.14
K	0.500	0.560	12.70	14.22
L	0.250	-	6.35	-
P	-	0.050	-	1.27
M	45°C TP		45°C TP	
R	0.050	-	1.27	-

This drawing is for reference only. Please refer to Digitron's published datasheet.